503127238 01/08/2015 PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW /	NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIG	ASSIGNMENT			
CONVEYING PARTY	DATA					
		Name	Name		Execution Date	
MOHIT RARNAMI					12/24/2014	
GAURAV GOYAL					12/24/2014	
RECEIVING PARTY	ΟΑΤΑ					
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City:	Austin	Austin				
State/Country:	TEXAS	TEXAS				
Postal Code:	Code: 78735					
Application Number: 1		14591924				
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		512-895-697	395-6979 DOCKETING@freescale.com			
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SIGNATURE:		/Cassi	/Cassie Ye/			
DATE SIGNED:		01/08/	01/08/2015			
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ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **MOHIT PARNAMI AND GAURAV GOYAL, BOTH OF INDIA**, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in <u>LOW LEAKAGE FLIP-FLOP CIRCUIT</u> (Docket No. AM20980AM), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the

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We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

DATE: 12-24-2014 MOHIT PARNAMI First Witness DATE: 12-24-2014 (Month-Day-Year) Vieti Agarical SIGNATURE OF WITNESS PREETE Agernal PRINTED NAME OF WITNESS <u>Frencale Semiconductor</u> Moida PRINTED ADDRESS OF WITNESS Second Witness DATE: <u>12-2-4-2-5/4</u> (Month-Day-Year) SIGNATURE OF WITNESS Himanshu Mangal PRINTED NAME OF WITNESS <u>Freescale Semiconductor</u>, Norda PRINTED ADDRESS OF WITNESS

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AM20980AM -24-2014 2 DATE: GAURAV GOYAL First Witness - 2014 ot Agazwal DATE: SIGNATURE OF WITNESS (Month-Day-Year) Beete Agaswal PRINTED NAME OF WITNESS <u>Freccale</u> Semiconductor, Noida PRINTED ADDRESS OF WITNESS Second Witness 2-24-2014 DATE: SIGNATURE OF WITNESS (Month-Day-Year) Himanshie Mangal PRINTED NAME OF WITNESS <u>Facegale Semiconductor</u>, Noida PRINTED ADDRESS OF WITNESS 3

RECORDED: 01/08/2015

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